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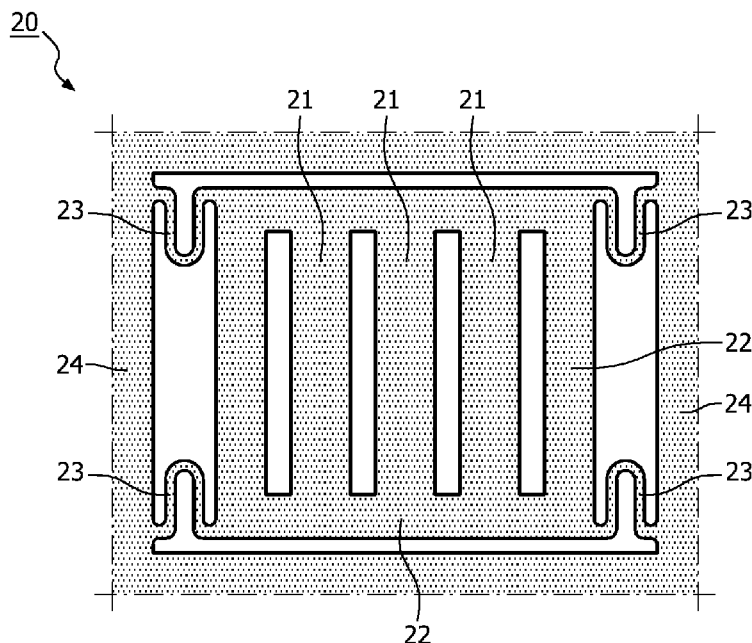
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(54) Title: DEVICE AND METHOD FOR POSITIONING ELECTRONIC COMPONENTS IN A PROCESSING TOOL



(57) Abstract: The invention relates to a device for positioning linearly displaceable electronic components, comprising: a linear lower guide and a linear upper guide for the electronic components, wherein at least one of the guides forms part of a flat metal sheet such that the guide is resiliently displaceable perpendicularly of the flat metal sheet. The invention also relates to a method for positioning linearly displaceable electronic components.

FIG. 3



TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, **Published:**
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— *with international search report (Art. 21(3))*

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— *as to applicant's entitlement to apply for and be granted
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